

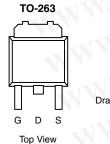


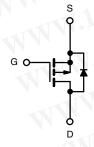
P-Channel 40-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$r_{DS(on)}\left(\Omega\right)$	I _D (A) ^a	Q _g (Typ.)			
- 40	0.005 at V _{GS} = - 10 V	- 110	185 nC			

• TrenchFET® Power MOSFET







Ordering Information: SUM110P04-05-E3 (Lead (Pb)-free)

P-Channel MOSFET

Parameter	31 100	Symbol	Limit	Unit	
Drain-Source Voltage Gate-Source Voltage		V _{DS}	- 40	V	
		V _{GS}	± 20		
	T _C = 25 °C	Cor	- 110 ^a	NN	
Continuous Dynin Current /T 175 %C\	T _C = 70 °C		- 110 ^a		
Continuous Drain Current (T _J = 175 °C)	T _A = 25 °C		39 ^{b, c}		
	T _A = 70 °C		33 ^{b, c}		
Pulsed Drain Current		I _{DM}	240	А	
Continuous Course Dusin Blade Courset	T _C = 25 °C	l _s CC	110		
Continuous Source-Drain Diode Current	T _A = 25 °C		10 ^{b, c}	-11	
Avalanche Current	L = 0.1 mH	I _{AS}	75		
Single-Pulse Avalanche Energy	L = 0.1 IIII	E _{AS}	281	mJ	
Dr. Carlot	T _C = 25 °C	100 7.	375	- 14	
Maximum Payar Dissination	T _C = 70 °C	D- <1	262	10/	
Maximum Power Dissipation	T _A = 25 °C	P_{D}	15 ^{b, c}	W	
	T _A = 70 °C		10.5 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	
Soldering Recommendations (Peak Temperature) ^{d, e}		N°To	260	-0	

1007.		-1100	7.0				
THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	8	10	°C/W		
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	0.33	0.4	3C/VV		

Notes:

- a. Package limited.b. Surface Mounted on 1" x 1" FR4 board.
- d. Maximum under Steady State conditions is 40 °C/W.

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SUM110P04-05

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Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit	
Static			1110		- CO	Mrs	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 40			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = - 250 μA	AT VIV	- 40	- 01	mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			- 5.5			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 2	- 3	- 4	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zava Cata Valtaga Drain Current	U P	V _{DS} = - 40 V, V _{GS} = 0 V	_S = - 40 V, V _{GS} = 0 V		- 1		
Zero Gate Voltage Drain Current	IDSS	V _{DS} = - 40 V, V _{GS} = 0 V, T _J = 55 °C			- 10	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = -10 \text{ V}$	- 120	- XX	loo_{-}	Α	
Drain-Source On-State Resistance ^a	r _{DS(on)}	V _{GS} = - 10 V, I _D = - 20 A		0.0041	0.005	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 20 A		75	100	S	
Dynamic ^b		1 CONTAIN	4 X		•		
Input Capacitance	C _{iss}			11300	<110	U >	
Output Capacitance	C _{oss}	V _{DS} = - 25 V, V _{GS} = 0 V, f = 1 MHz		1510	Non	pF	
Reverse Transfer Capacitance	C _{rss}	J. TIN		1000	-311		
Total Gate Charge	Q_{g}	of CONTRACT		185	280	nC	
Gate-Source Charge	Q_{gs}	V _{DS} = - 20 V, V _{GS} = - 10 V, I _D = - 110 A		48	- 41		
Gate-Drain Charge	Q_{gd}	COM		42	NIN	, 1	
Gate Resistance	R_{g}	f = 1 MHz		4.0		Ω	
Turn-On Delay Time	t _{d(on)}	COM		25	40	10.3	
Rise Time	t _r	$V_{DD} = -20 \text{ V}, R_L = 0.18 \Omega$		290	440	ns	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 110 A, V_{GEN} = - 10 V, R_g = 1 Ω	ſ	110	165		
Fall Time	t _f			35	55		
Drain-Source Body Diode Characteristics	-11	N. Inc.	- 7	<u>'</u>		TIN	
Continuous Source-Drain Diode Current I_S $T_C = 25$ °C		T _C = 25 °C			- 110	^	
Pulse Diode Forward Current ^a	I _{SM}	MIN TON			- 240	Α	
Body Diode Voltage	V_{SD}	I _S = - 20 A		- 0.8	- 1.5	V	
Body Diode Reverse Recovery Time	t _{rr}	100 - OM.		70	105	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = - 20 A, di/dt = 100 A/μs, T _J = 25 °C		130	200	nC	
Reverse Recovery Fall Time	t _a	$\frac{1}{1} = \frac{1}{2} = \frac{1}$	·	37			
Reverse Recovery Rise Time	t _b			33		ns	

Notes:

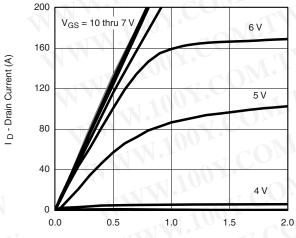
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

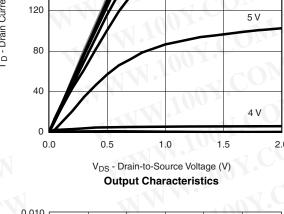
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

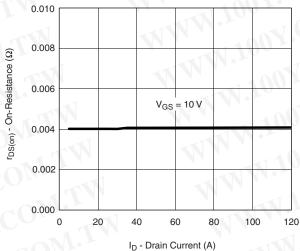
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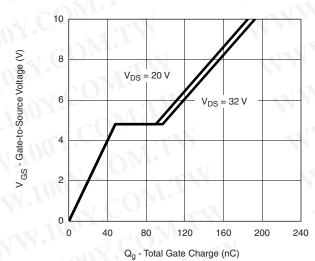
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



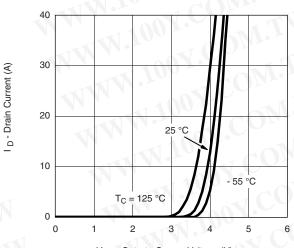




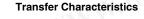
On-Resistance vs. Drain Current

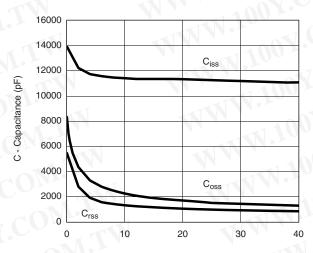


Gate Charge



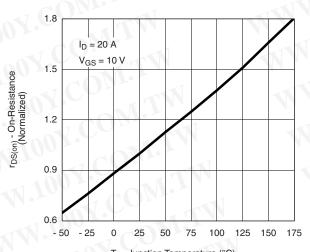
V_{GS} - Gate-to-Source Voltage (V)





V_{DS} - Drain-to-Source Voltage (V)

Capacitance



T_J - Junction Temperature (°C) On-Resistance vs. Junction Temperature

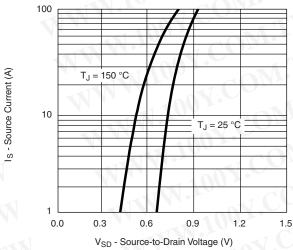
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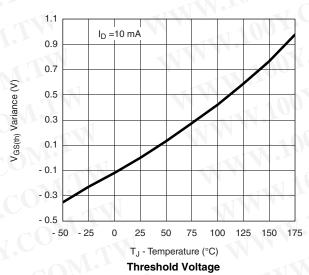
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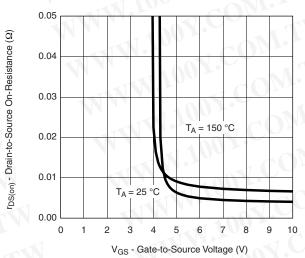
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

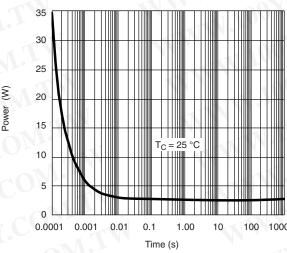


Source-Drain Diode Forward Voltage

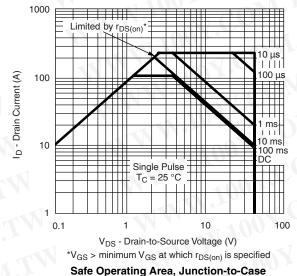




On-Resistance vs. Gate-to-Source Voltage



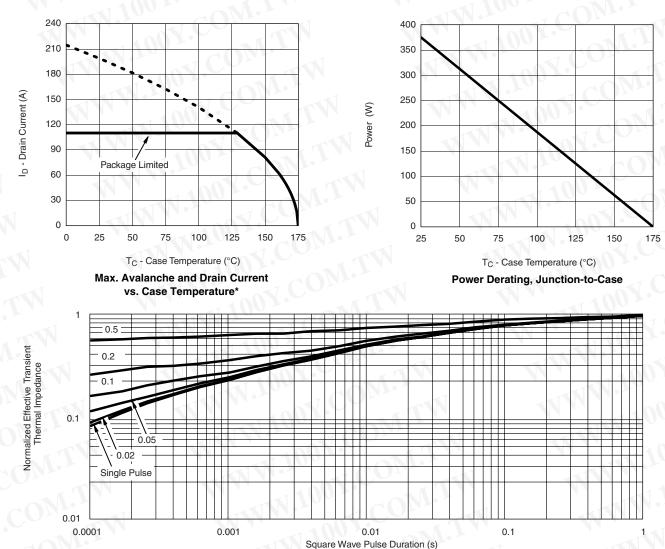
Single Pulse Power, Junction-to-Ambient



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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

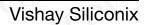


Normalized Thermal Transient Impedance, Junction-to-Case

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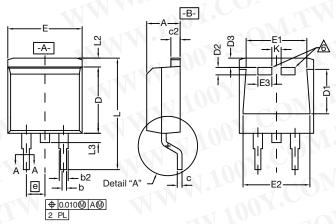
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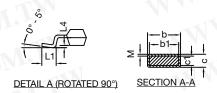
^{*} The power dissipation P_D is based on $T_{J(max)} = 175$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





TO-263 (D2PAK): 3-LEAD





		INC	HES	IVIILLIN	/IEIEKS		
		-		MILLIMETERS			
DIM.		MIN.	MAX.	MIN.	MAX.		
Α		0.160	0.190	4.064	4.826		
	b	0.020	0.039	0.508	0.990		
	b1	0.020	0.035	0.508	0.889		
	b2	0.045	0.055	1.143	1.397		
c*	Thin lead	0.013	0.018	0.330	0.457		
U	Thick lead	0.023	0.028	0.584	0.711		
N 1	Thin lead	0.013	0.017	0.330	0.431		
c1	Thick lead	0.023	0.027	0.584	0.685		
	c2	0.045	0.055	1.143	1.397		
	D	0.340	0.380	8.636	9.652		
	D1	0.220	0.240	5.588	6.096		
1	D2	0.038	0.042	0.965	1.067		
	D3	0.045	0.055	1.143	1.397		
	E	0.380	0.410	9.652	10.414		
J	E1	0.245		6.223			
	E2	0.355	0.375	9.017	9.525		
	E3	0.072	0.078	1.829	1.981		
	е	0.100	BSC	2.54	BSC		
	K	0.045	0.055	1.143	1.397		
JY	L	0.575	0.625	14.605	15.875		
	L1	0.090	0.110	2.286	2.794		
	L2	0.040	0.055	1.016	1.397		
L3		0.050	0.070	1.270	1.778		
L4		0.010	BSC	0.254	254 BSC		
	М		0.002	- 1	0.050		

Notes

- 1. Plane B includes maximum features of heat sink tab and plastic.
- 2. No more than 25 % of L1 can fall above seating plane by max. 8 mils.
- 3. Pin-to-pin coplanarity max. 4 mils.
- *: Thin lead is for SUB, SYB. Thick lead is for SUM, SYM, SQM.
- Use inches as the primary measurement.
- his feature is for thick lead.

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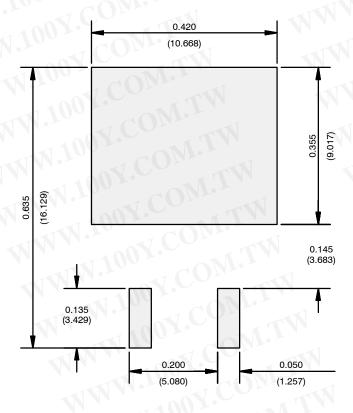


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RECOMMENDED MINIMUM PADS FOR D2PAK: 3-Lead

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Recommended Minimum Pads Dimensions in Inches/(mm)

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